1.8V / 2.5V, 10GHz ÷4 Clock Divider with CML Outputs

Multi-Level Inputs w/ Internal Termination

Description

The NB7V33M is a differential $\div 4$ Clock divider with asynchronous reset. The differential Clock inputs incorporate internal 50 Ω termination resistors and will accept LVPECL, CML and LVDS logic levels. The NB7V33M produces a $\div 4$ output copy of an input Clock operating up to 10 GHz with minimal jitter. The Reset pin is asserted on the rising edge. Upon powerup, the internal flip – flops will attain a random state; the Reset allows for the synchronization of multiple NB7V33M's in a system. The 16 mA differential CML output provides matching internal 50 Ω termination which guarantees 400 mV output swing when externally receiver terminated with 50 Ω to V_{CC}.

The NB7V33M is the $\div 4$ version of the NB7V32M ($\div 2$) and is offered in a low profile 3 mm x 3 mm 16-pin QFN package.

The NB7V33M is a member of the GigaComm[™] family of high performance clock products. Application notes, models, and support documentation are available at www.onsemi.com.

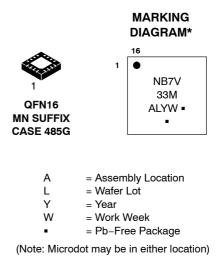
Features

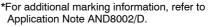
- Maximum Input Clock Frequency > 10 GHz, typical
- 260 ps Typical Propagation Delay
- 35 ps Typical Rise and Fall Times
- Differential CML Outputs, 400 mV Peak-to-Peak, Typical
- Operating Range: $V_{CC} = 1.71$ V to 2.625 V with GND = 0 V
- Internal 50 Ω Input Termination Resistors
- Random Clock Jitter < 0.8 ps RMS
- QFN-16 Package, 3 mm x 3 mm
- -40°C to +85°C Ambient Operating Temperature
- These are Pb-Free Devices



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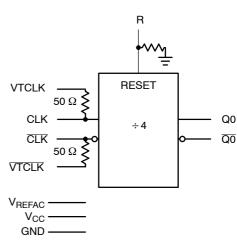


Figure 1. Simplified Logic Diagram

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 9 of this data sheet.

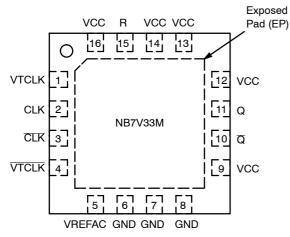


Figure 2. Pin Configuration (Top View)

Table 2. PIN DESCRIPTION

Table 1. TRUTH TABLE

| CLK | CLK | R | Q | Q |
|-----|-----|---|---------|---------|
| х | x | Н | L | Н |
| Z | W | L | CLK ÷ 4 | CLK ÷ 4 |

Z = Low to High Transition

W = High to Low Transition

X = Don't Care

| Pin | Name | I/O | Description |
|-----|--------|----------------------------|--|
| 1 | VTCLK | _ | Internal 50 Ω Termination Pin for CLK |
| 2 | CLK | LVPECL, CML, LVDS Input | Non-inverted Differential CLK Input. Note 1. |
| 3 | CLK | LVPECL, CML, LVDS Input | Inverted Differential CLK Input. Note 1. |
| 4 | VTCLK | - | Internal 50 Ω Termination Pin for $\overline{\text{CLK}}$ |
| 5 | VREFAC | - | Internally Generated Output Voltage Reference for Capacitor-Coupled Inputs, Only |
| 6 | GND | - | Negative Supply Voltage |
| 7 | GND | - | Negative Supply Voltage |
| 8 | GND | - | Negative Supply Voltage |
| 9 | Vcc | - | Positive Supply Voltage. Note 2. |
| 10 | Q | CML Output | Inverted Differential Output |
| 11 | Q | CML Output | Non-Inverted Differential Output |
| 12 | Vcc | - | Positive Supply Voltage. Note 2. |
| 13 | Vcc | - | Positive Supply Voltage. Note 2. |
| 14 | Vcc | - | Positive Supply Voltage. Note 2. |
| 15 | R | LVCMOS Input | Asynchronous Reset Input. Internal 75 k Ω pulldown to GND. |
| 16 | Vcc | - | Positive Supply Voltage. Note 2. |
| _ | EP | - | The Exposed Pad (EP) on the QFN-16 package bottom is thermally connected to the die for improved heat transfer out of package. The exposed pad must be attached to a heat-sinking conduit. The pad is electrically connected to the die, and must be electrically and thermally con- nected to GND on the PC board. |

 In the differential configuration when the input termination pins (VTCLK/VTCLK) are connected to a common termination voltage or left open, and if no signal is applied on CLK/CLK input, then the device will be susceptible to self-oscillation. Q/Q outputs have internal 50 Ω source termination resistors.

2. All V_{CC} and GND pins must be externally connected to a power supply for proper operation.

Table 3. ATTRIBUTES

| Characteristic | Value | | | |
|--|----------------------|-------------------|--|--|
| ESD Protection Human Body Model Machine Model | | > 4 kV > 200 V | | |
| R _{PD} – Reset Input Pulldown Resistor | 75 kΩ | | | |
| Moisture Sensitivity (Note 3) | Level 1 | | | |
| Flammability Rating | UL 94 V-0 @ 0.125 in | | | |
| Transistor Count | 190 | | | |
| Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test | | | | |

3. For additional information, see Application Note AND8003/D.

Table 4. MAXIMUM RATINGS

| Symbol | Parameter | Condition 1 | Condition 2 | Rating | Unit |
|----------------------|--|--------------------|------------------|------------------------------|------|
| V _{CC} | Positive Power Supply | GND = 0 V | | 3.0 | V |
| V _{IN} | Positive Input Voltage | GND = 0 V | | –0.5 to V _{CC} +0.5 | V |
| V _{INPP} | Differential Input Voltage D - D | | | 1.89 | V |
| I _{IN} | Input Current Through R_T (50 Ω Resistor) | | | ±40 | mA |
| I _{OUT} | Output Current Through R_T (50 Ω Resistor) | | | ±40 | mA |
| IVFREFAC | VREFAC Sink/Source Current | | | ±1.5 | mA |
| T _A | Operating Temperature Range | | | -40 to +85 | °C |
| T _{stg} | Storage Temperature Range | | | -65 to +150 | °C |
| θ_{JA} | Thermal Resistance (Junction-to-Ambient) (Note 4) | 0 lfpm 500 lfpm | QFN-16 QFN-16 | 42 35 | °C/W |
| θ^{JC} | Thermal Resistance (Junction-to-Case) (Note 4) | | QFN-16 | 4 | °C/W |
| T _{sol} | Wave Solder Pb-Free | | | 265 | °C |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

4. JEDEC standard multilayer board - 2S2P (2 signal, 2 power) with 8 filled thermal vias under exposed pad.

| Symbol | Characteristic | Min | Тур | Мах | Unit |
|--------------------|---|--|--|--|------|
| POWER | SUPPLY CURRENT | | | | |
| I _{CC} | Power Supply Current (Inputs and Outputs Open) $\begin{array}{l} Vcc = 2.5 \ V \pm 5\% \\ Vcc = 1.8 \ V \pm 5\% \end{array}$ | | 95 85 | 115 100 | mA |
| CML OUT | IPUTS | 1 | | <u> </u> | |
| V _{OH} | Output HIGH Voltage (Note 6) Vcc = 2.5 V Vcc = 1.8 V | V _{CC} – 30 2470 1770 | V _{CC} – 10 2490 1790 | V _{CC} 2500 1800 | mV |
| V _{OL} | Output LOW Voltage (Note 6) Vcc = 2.5 V Vcc = 1.8 V | $\begin{matrix} V_{CC} - 650 \\ 1850 \\ V_{CC} - 600 \\ 1200 \end{matrix}$ | $V_{CC} - 550$ 1950 $V_{CC} - 500$ 1300 | $\begin{matrix} V_{CC} - 450 \\ 2050 \\ V_{CC} - 400 \\ 1400 \end{matrix}$ | mV |
| DIFFERE | NTIAL INPUTS DRIVEN SINGLE-ENDED (Note 7) (Figures 5 & 6) | | | | |
| V _{th} | Input Threshold Reference Voltage Range (Note 8) | 1050 | | V _{CC} - 100 | mV |
| V _{IH} | Single-ended Input HIGH Voltage | V _{th} + 100 | | V _{CC} | mV |
| V _{IL} | Single-ended Input LOW Voltage | GND | | V _{th} – 100 | mV |
| V _{ISE} | Single-ended Input Voltage (V _{IH} - V _{IL}) | 200 | | 1200 | mV |
| VREFAC | | | | | |
| V _{REFAC} | Output Reference Voltage @100 μA for Capacitor– Coupled Inputs, Only $$V_{CC}$$ = 2.5 V $$V_{CC}$$ = 1.8 V | $V_{CC} - 850 \ V_{CC} - 750$ | | $\begin{array}{c} V_{CC}-500\\ V_{CC}-450 \end{array}$ | mV |
| DIFFERE | NTIAL INPUTS DRIVEN DIFFERENTIALLY (Figures 7 & 8) (Note 9) | - | | | |
| V _{IHD} | Differential Input HIGH Voltage | | | V _{CC} | mV |
| V _{ILD} | Differential Input LOW Voltage | GND | | V _{CC} – 100 | mV |
| V _{ID} | Differential Input Voltage (V _{IHD} – V _{ILD}) | 100 | | 1200 | mV |
| V _{CMR} | Input Common Mode Range (Differential Configuration, Note 10) (Fig- ure 9) | 1050 | | V _{CC} – 50 | mV |
| I _{IH} | Input HIGH Current (VTx/VTx Open) | -150 | | 150 | μA |
| I _{IL} | Input LOW Current (VTx/VTx Open) | -150 | | 150 | μA |
| CONTRO | L INPUT (Reset pin) | | | | |
| V _{IH} | Input HIGH Voltage for Control Pin | V _{CC} – 200 | | V _{CC} | mV |
| V _{IL} | Input LOW Voltage for Control Pin | GND | | 200 | mV |
| IIH | Input HIGH Current | -150 | | 150 | μA |
| IIL | Input LOW Current | -150 | | 150 | μA |
| TERMIN/ | ATION RESISTORS | | | | |
| R _{TIN} | Internal Input Termination Resistor | 45 | 50 | 55 | Ω |
| R _{TOUT} | Internal Output Termination Resistor | 45 | 50 | 55 | Ω |

operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

5. Input and output parameters vary 1:1 with V_{CC} .

6. CML outputs loaded with 50– Ω to V_{CC} for proper operation.

7. Vth, V_{IH} , $V_{IL_{m}}$ and V_{ISE} parameters must be complied with simultaneously. 8. Vth is applied to the complementary input when operating in single–ended mode.

VII IS applied to the complementary input when operating in single-ended mode.
V_{IHD}, V_{ILD}, V_{ID} and V_{CMR} parameters must be complied with simultaneously.
V_{CMR} min varies 1:1 with GND, V_{CMR} max varies 1:1 with V_{CC}. The V_{CMR} range is referenced to the most positive side of the differential input signal.

| Symbol | Characteristic | | | Тур | Max | Unit |
|--|---|--|------------|--|------------|--------|
| f _{MAX} | Maximum Input Clock Frequency | | 10 | 11 | | GHz |
| V _{OUTPP} | Output Voltage Amplitude (@ $V_{INPPmin}$) $f_{in} \le 10 \text{ GHz}$ (Note 12) (Figure 3) | Output Voltage Amplitude (@ $V_{INPPmin}$) $f_{in} \le 10 \text{ GHz}$ (Note 12) (Figure 3) | | 400 | | mV |
| t _{PLH} , t _{PHL} | Propagation Delay to Differential Outputs, @ 1 GHz, measured at differential crosspoint | CLK/CLK to Q, Q R to Q, Q | 150 500 | 200 600 | 350 700 | ps |
| t _{PLH} TC | Propagation Delay Temperature Coefficient | | | 50 | | ∆fs/°C |
| t _{skew} | Duty Cycle Skew (Note 13) Device – Device skew (tpdmax – tpdmin) | | | | 20 50 | ps |
| t _{RR} | Reset Recovery (See Figure 16) | | 550 | 135 | | ps |
| t _{PW} | Minimum Pulse Width R | | 500 | 200 | | ps |
| t _{DC} | Output Clock Duty Cycle (Reference Duty Cycle = 50%) $f_{in} \le 10 \text{ GHz}$ | | 45 | 50 | 55 | % |
| ΦN | Phase Noise, f _c = 1 GHz 10 kHz 100 kHz 1 MHz 10 MHz 20 MHz 40 MHz | | | -144 -147 -152 -152 -152 -153 | | dBc |
| $t_{j\phi N}$ | Integrated Phase Jitter (Figure x) $f_c = 1 \text{ GHz}$, 12 kHz – 20 MHz Offset | | | 35 | | fs |
| t _{JITTER} | RJ – Output Random Jitter (Note 14) $f_{in} \leq 10.0 \text{ GHz}$ | | | 0.2 | 0.8 | ps RMS |
| V _{INPP} | Input Voltage Swing (Differential Configuration) (Figure 11) (Note 15) | | 200 | | 1200 | mV |
| t _r , t _f | Output Rise/Fall Times @ 1 GHz (20% – 80%), Q, Q | | 20 | 35 | 60 | ps |

| Table 6. AC CHARACTERISTICS V_{CC} = 1.71 V to 2.625 V; GND = 0 V; T_A = -40°C to 85°C (Note 11) |
|--|
|--|

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

Measured using a 1 GHz, V_{INPP}min, 50% duty-cycle clock source. All output loading with external 50 Ω to V_{CC}. Input edge rates 40 ps (20% – 80%).

12. Output voltage swing is a single-ended measurement operating in differential mode.

13. Duty cycle skew is defined only for differential operation when the delays are measured from cross-point of the inputs to the cross-point of the outputs. Duty cycle skew is measured between differential outputs using the deviations of the sum of Tpw- and Tpw+ @ 1 GHz. Skew is measured between outputs under identical transitions and conditions.

14. Additive RMS jitter with 50% duty cycle clock signal.

15. Input voltage swing is a single-ended measurement operating in differential mode.

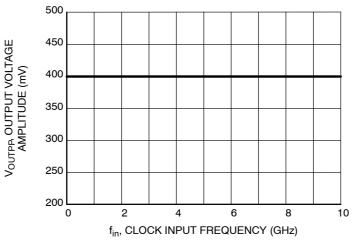
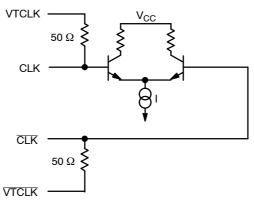
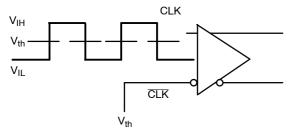
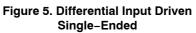


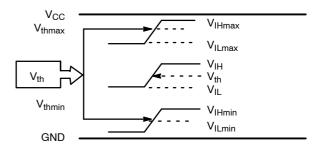
Figure 3. Output Voltage Amplitude (V_{OUTPP}) vs. Input Frequency (f_{in}) at Ambient Temperature (Typical)



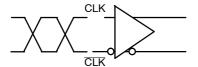




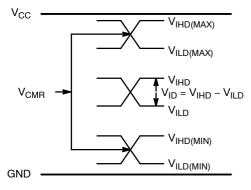




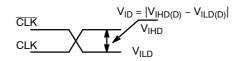




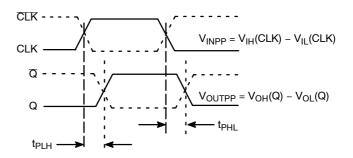




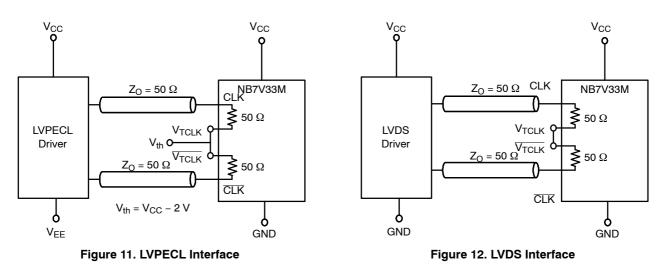


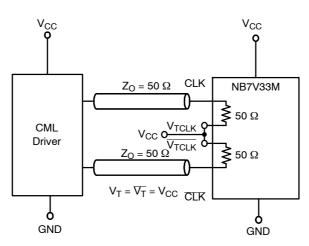


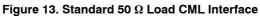


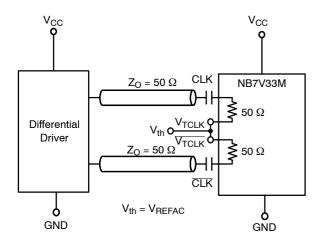


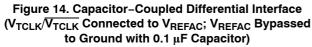


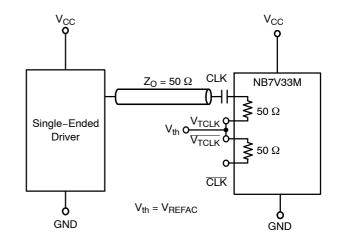


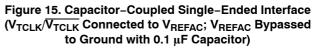












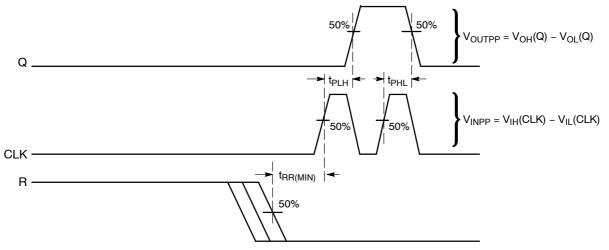


Figure 16. AC Reference Measurement (Timing Diagram)

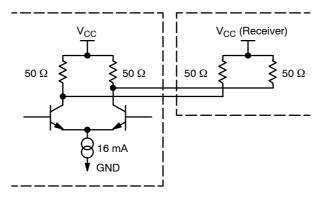


Figure 17. Typical CML Output Structure and Termination

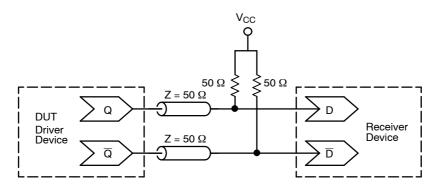


Figure 18. Typical Termination for CML Output Driver and Device Evaluation

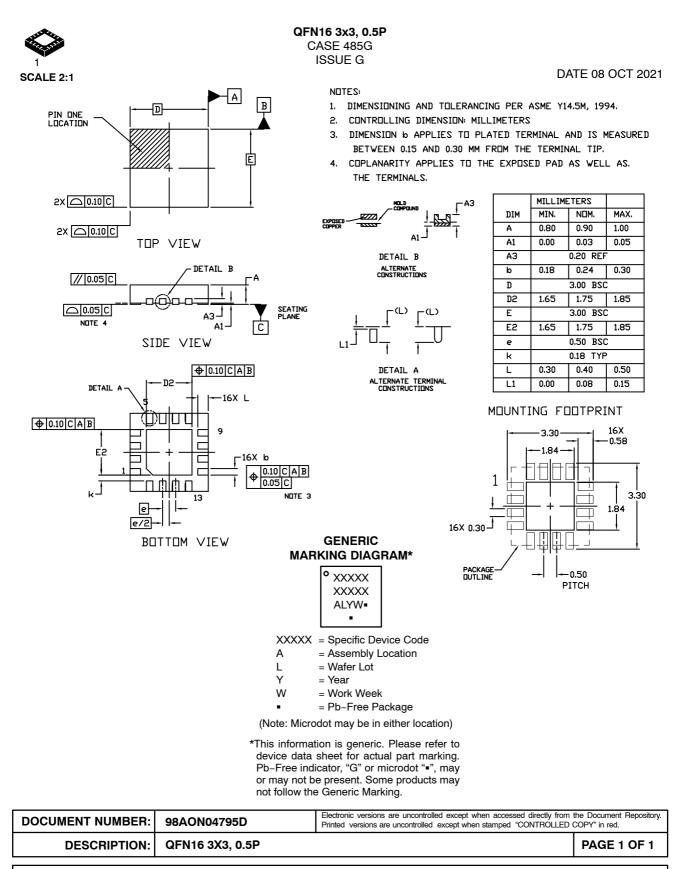
DEVICE ORDERING INFORMATION1

| Device | Package | Shipping [†] |
|---------------|---------------------|-----------------------|
| NB7V33MMNG | QFN-16 (Pb-Free) | 123 Units / Rail |
| NB7V33MMNHTBG | QFN-16 (Pb-Free) | 100 / Tape & Reel |
| NB7V33MMNTXG | QFN-16 (Pb-Free) | 3000 / Tape & Reel |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

The products described herein (NB7V33M), may be covered by U.S. patents including 6,362,644. There may be other patents pending. GigaComm is a trademark of Semiconductor Component Industries, LLC (SCILLC).

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